
UNITED STATES
SECURITIES AND EXCHANGE COMMISSION
Washington, D.C. 20549

FORM 8-K

CURRENT REPORT
Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): June 10, 2010

TTM TECHNOLOGIES, INC.

(Exact name of registrant as specified in its charter)

DELAWARE

(State or other Jurisdiction of
Incorporation)

0-31285

(Commission File Number)

91-1033443

(IRS Employer Identification No.)

2630 SOUTH HARBOR BOULEVARD
SANTA ANA, CALIFORNIA

(Address of Principal Executive Offices)

92704

(Zip Code)

Registrant's telephone number, including area code: (714) 327-3000

(Former name or former address if changed since last report.)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions:

- ☐ Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- ☐ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- ☐ Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
- ☐ Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))
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Item 7.01. Regulation FD Disclosure.

The Company is furnishing this Report on Form 8-K pursuant to Regulation FD in connection with the disclosure of textual information from a slide show presentation given at the UBS Global Technology and Service Conference on June 10, 2010.

The information in this Report on Form 8-K (including the exhibit) is furnished pursuant to Item 7.01 and shall not be deemed to be “filed” for the purpose of Section 18 of the Securities Exchange Act of 1934 or otherwise subject to the liabilities of that section. This Report will not be deemed an admission as to the materiality of any information in the report that is required to be disclosed solely by Regulation FD.

The Company does not have, and expressly disclaims, any obligation to release publicly any updates or any changes in the Company’s expectations or any change in events, conditions, or circumstances on which any forward-looking statement is based.

The information included with this Report includes graphic images or slides used in the presentation. These slides will also be available for viewing at our website located at www.ttmtech.com, although we reserve the right to discontinue that availability at any time.

The information in this Report includes references to “EBITDA.” EBITDA means earnings before interest expense, income taxes, depreciation and amortization. We present EBITDA to enhance the understanding of our operating results. EBITDA is a key measure we use to evaluate our operations. In addition, we provide our EBITDA because we believe that investors and securities analysts will find EBITDA to be a useful measure for evaluating our operating performance and comparing our operating performance with that of similar companies that have different capital structures and for evaluating our ability to meet our future debt service, capital expenditures and working capital requirements. However, EBITDA should not be considered as an alternative to cash flows from operating activities as a measure of liquidity or as an alternative to net income as a measure of operating results in accordance with accounting principles generally accepted in the United States.

Item 9.01. Financial Statements and Exhibits

(a) *Financial Statements of Business Acquired.*

Not applicable.

(b) *Pro Forma Financial Information.*

Not applicable.

(c) *Exhibits.*

Exhibit 99.1. Slides presented at the UBS Global Technology and Service Conference on June 10, 2010.

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

TTM TECHNOLOGIES, INC.

Date: June 10, 2010

By: /s/ Steven W. Richards

Steven W. Richards
Chief Financial Officer



Global Presence - Local Knowledge

UBS Global Technology & Service Conference

June 10, 2010

Forward-Looking Statements

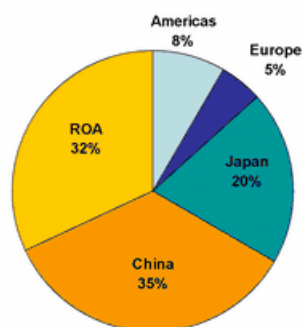
This presentation contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements. These risks and uncertainties include, but are not limited to, risks associated with obtaining regulatory approvals in the U.S. and China, the company's dependence upon the electronics industry, the risks associated with integrating acquisitions, the company's dependence upon a small number of customers, general economic conditions and specific conditions in the markets TTM addresses, the unpredictability of and potential fluctuation in future revenues and operating results, increased competition from low-cost foreign manufacturers, and other "Risk Factors" set forth from time to time in the company's SEC filings.



1. **Industry Overview**
2. **TTM Technologies Overview**
3. Meadville Overview
4. TTM – Meadville Combination
5. Financial Information

Global PCB Market by Region

2009 Global Market Share



ROA = Asia excluding China and Japan

Regional Growth History
& Projections

\$ in billions

Region	2000	2009	2010	2011	2012e	CAGR '09-'12
Americas	\$10.9	\$3.4	\$3.7	\$3.8	\$3.6	1.8%
Europe	\$6.7	\$2.0	\$2.2	\$2.2	\$2.2	2.6%
Japan	\$11.3	\$8.3	\$8.7	\$9.0	\$8.5	1.1%
China	\$3.4	\$14.3	\$16.6	\$18.2	\$19.6	11.2%
ROA	\$8.7	\$13.1	\$15.0	\$16.3	\$16.0	7.0%
World	\$41.0	\$41.1	\$46.2	\$49.5	\$49.9	6.8%

Source: Prismark May10

2009 Global Ranking

Top 10 World PCB Makers

Rank	Company	Revenue est.	Rank	Company	Revenue est.
1	Unimicron	\$1,734	6	CMK	\$978
2	Ibiden	\$1,732	7	KB PCB Group	\$923
3	Nippon Mektron	\$1,446	8	SEMCO	\$895
4	TTM (includes Meadville pro forma)	\$1,131	9	Young Poon Group	\$887
5	Tripod	\$1,028	10	Nanya PCB	\$848

Represents approximately 29% of total world PCB output

Top 5 North America PCB Makers

Rank	Company	Revenue est.
1	TTM	\$506
2	DDi (includes Coretec)	\$222
3	Sanmina	\$150
4	EIT	\$130
5	Merix	\$115

Represents approximately 32% of total Americas PCB output

Top 5 China PCB Makers

Rank	Company	Revenue est.
1	Tripod	\$907
2	KB PCB Group	\$870
3	Foxconn	\$750
4	Meadville Group	\$624
5	Multek	\$590

Represents approximately 26% of total China PCB output

Note: 2009 estimated revenues for PCB segment only
Total TTM – Meadville pro forma revenue for 2009 \$1.2 billion

NT Information January 2010



TTM Strategy



Total Customer Solution

Product Life Cycle

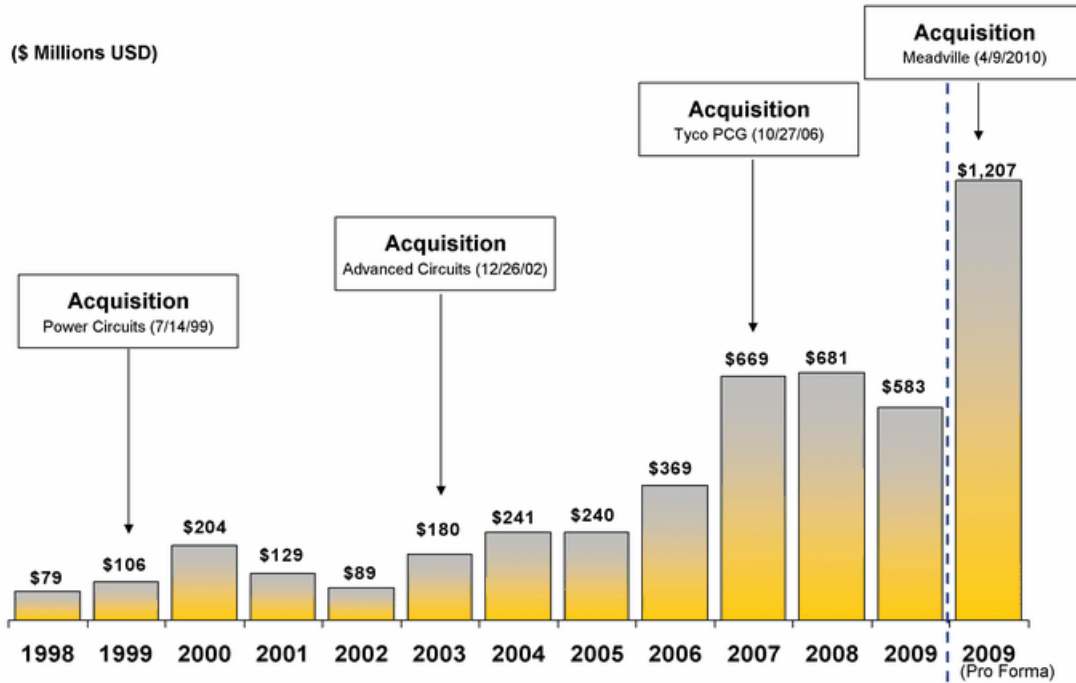


Total Solution Capabilities

- Engineering support
- Prototype
- Low volume / High mix
- Medium volume / Ramp
- Volume production

TTM Revenue Trends

(\$ Millions USD)



TTM Technologies



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Meadville PCB Overview

Company Facts

- Established in 1985
- FY2009 Sales: \$625 million
- Specializes in manufacturing high-end, advanced technology and complex PCBs
- Over 13,000 employees located in 8 factories (7 in China and 1 in Hong Kong)
- Top 5 manufacturer amongst China PCB manufacturers
- Pioneer in China and manufacturing advanced technology HDI PCBs, Quick Turn Services and IC Substrates in China
- Average layer count of 7.9 with highest layer count of 12 in China at SYE facility

Business Model

- Grow organically through capacity expansion
- Invest & Focus on high technology business
- Able to produce High mix, Low volume & Low Mix, High volume with layer count & ASP improvement YOY

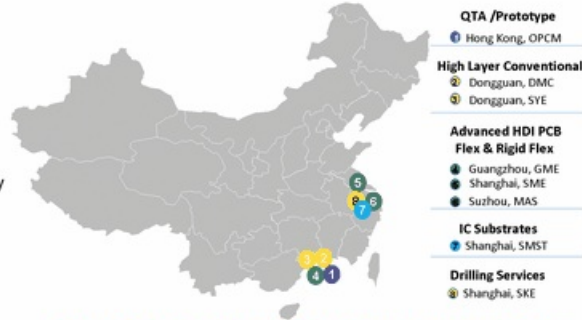
Product Strategy

- Thin & Light – Fine Line product applications
- Thick & Odd Size – Complex Design for high speed applications

Product Applications for 2009

Communications, Networking	40%
Handsets	21%
Computer	24%
Consumer	3%
Others (include medical, automotive)	12%

Meadville, a leading PCB Manufacturer in Asia



Meadville's footprint of specialized facilities in Hong Kong & China

Key Customers

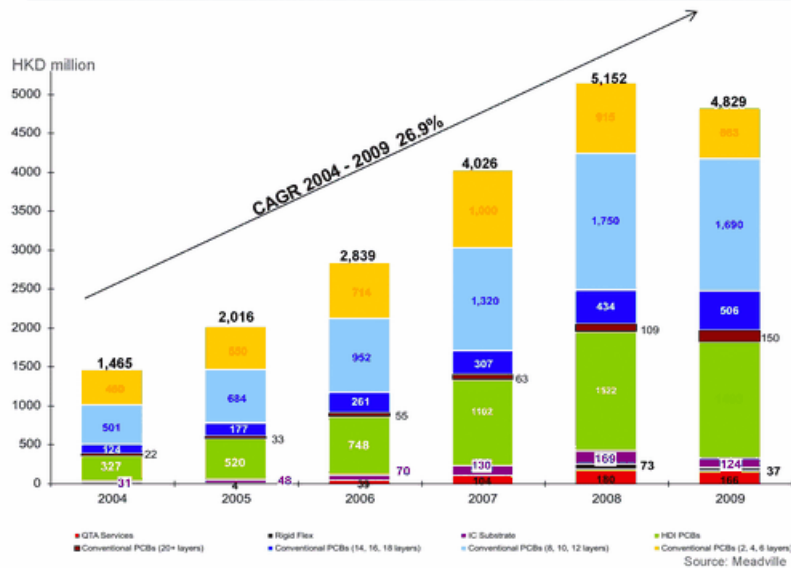
- China – Huawei, ZTE, Longcheer, TCL, DaTang
- International – AMD, APPLE, Ericsson, Intel, IBM, Alcatel, Fujitsu

Competitors

- China – Multek, Viasystems
- Japan – Ibiden, CMK, Shinko
- Taiwan – Nanya, Unimicron, Tripod
- US – DDI, Merix

Meadville Product & Revenue Trend

Increase of high technology products

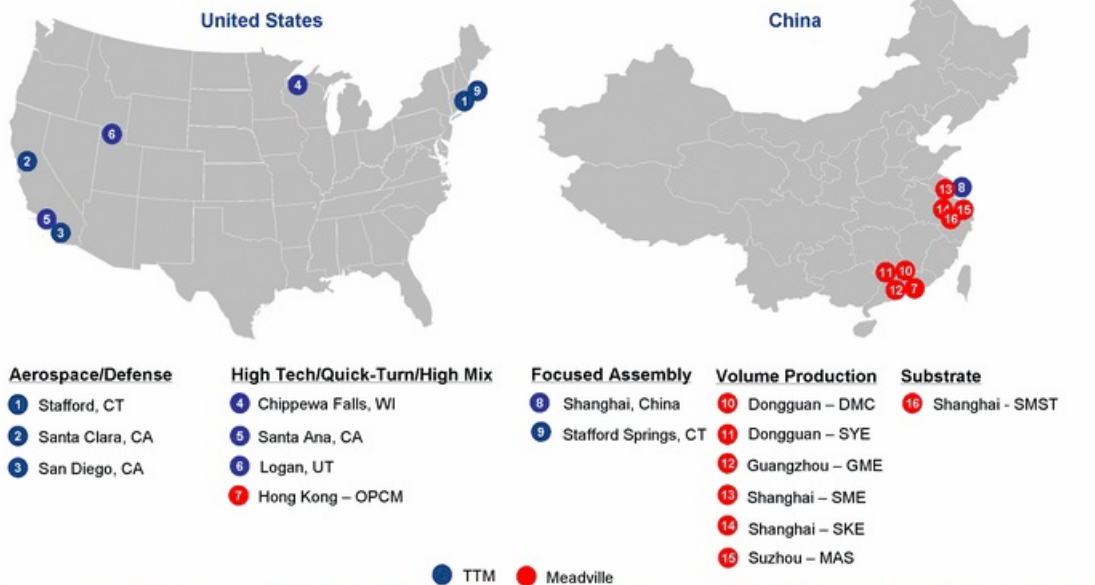


- Increased proportion of high technology products and decreased proportion of lower layer count products
- Positive growth for 14L+ and 20L+ PCBs

Global Manufacturing Footprint

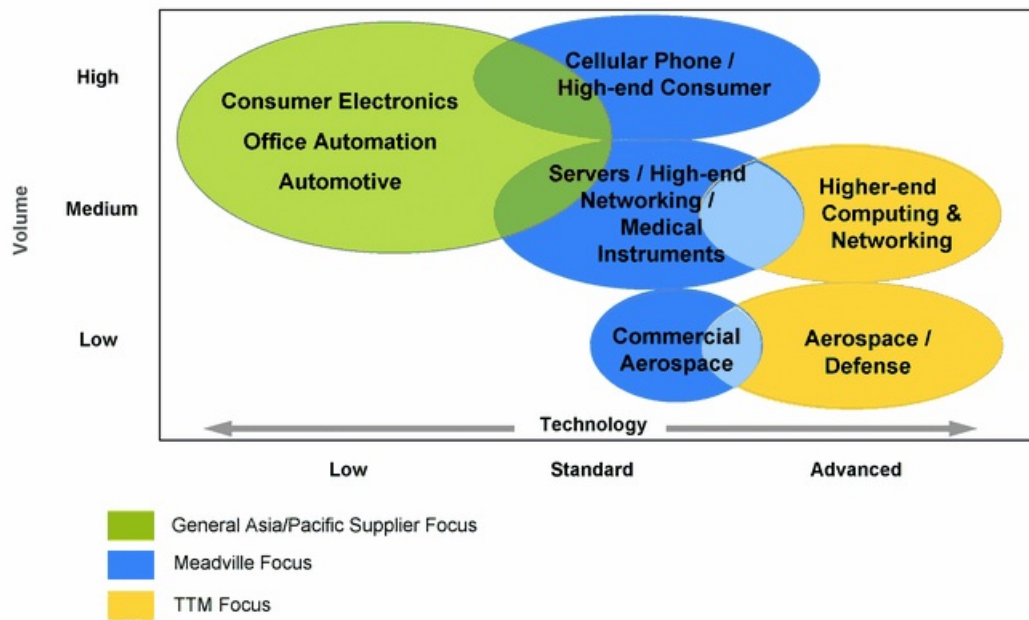
Integrated manufacturing platform enables TTM to execute a global facility specialization strategy

- Seamless integration across distinct facilities enables successful one-stop shop solution for commercial customers
- No planned facility closures



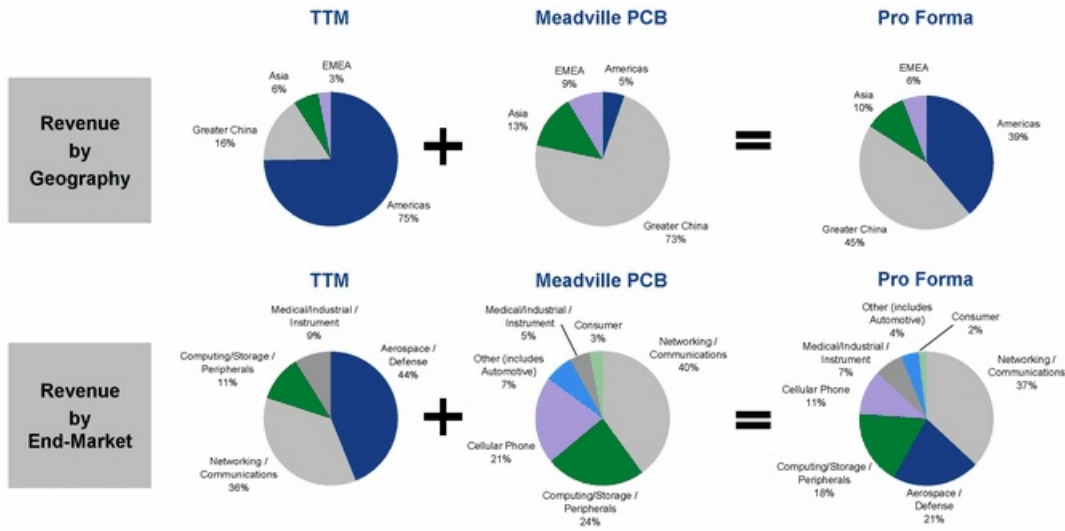
TTM Technologies

PCB Product Positioning



Diversifying Revenue Base

The combination creates a leading global manufacturer with a highly diversified revenue mix

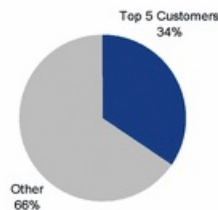


Source: Company filings. Revenue for the calendar year 2009 period.

Notes: Americas includes United States, Canada, Central and South America. Greater China includes China, Hong Kong and Taiwan. Asia includes Asian countries excluding Greater China. EMEA includes Europe, Middle East and Africa.

Diversifying Customer Base

TTM 2009 Revenue Contribution by Customer

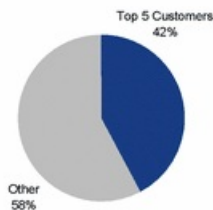


Top 5 Customers

Cisco Systems
Huawei
Juniper Networks
Northrop Grumman
Raytheon



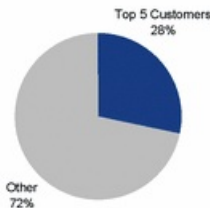
Meadville PCB 2009 Revenue Contribution by Customer



Top 5 Customers

Apple
Ericsson
Huawei
IBM
ZTE

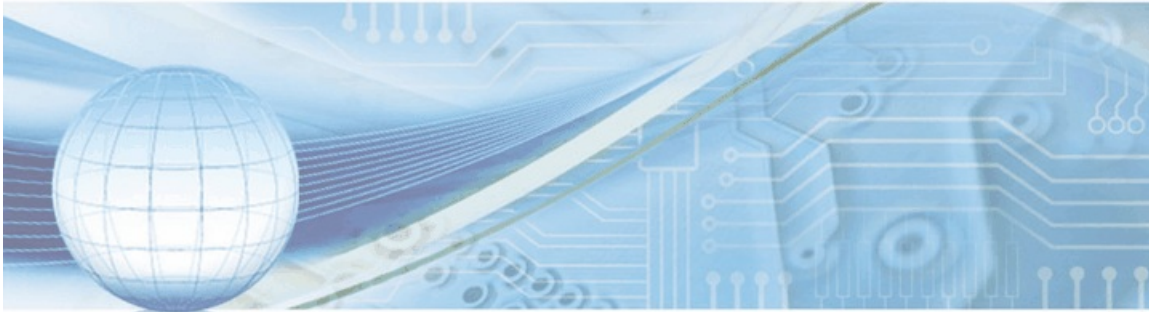
Pro Forma 2009 Revenue Contribution by Customer



Top 5 Customers

Apple
Ericsson
Huawei
Raytheon
ZTE

Source: Company filings, Management



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Transaction Summary

- Final purchase price
 - \$114 million in cash
 - 36.3 million shares of TTM stock
 - Closing market value of \$329 million assuming closing market price of \$9.06 per share on April 8, 2010
 - Assumed \$433 million of Meadville debt
 - Total: \$876 million
- EBITDA multiple
 - \$876 million / \$114.6 million adjusted EBITDA = 7.6 implied multiple
- Leverage ratio
 - Including TTM's convertible debt of \$175 million, initial leverage ratio is about 3.3 times combined 2009 EBITDA
 - Goal is to be under 3 times EBITDA within first year following deal close

Update on Board & Stockholders

- Ownership of shares
 - 36.3 million shares issued: 26.2 million to Tang family and 10.1 million to minority shareholders
 - Meadville's minority investors requested to sell approximately 1.3 million shares of TTM stock
 - Tang family, TTM's largest minority shareholder, acquired these shares and holds approximately 35 percent stake in TTM
- Trading restrictions
 - Tang family agreement prohibits sale of shares for 18 months; credit agreement requires Tangs to hold 20 percent stake in TTM
- Expansion of board
 - Addition of Tom Tang, Managing Director of Asia Pacific Region
 - Three new Government Security Committee members

Accretion and Synergies

Accretion estimate

- Transaction expected to be accretive in the third quarter of 2010

Revenue synergies

- Qualification process varies by customer
- Asian facilities ran at 75 to 95 percent of capacity in the first quarter
- Expanding capacity to accommodate growth
- 2010 potential from “simple qualification” customers
- Targeting “comprehensive qualification” customers for late 2010 and 2011

Cost synergies

- Minimal duplicative public company costs
- Better negotiations on direct materials due to larger scale of combined operations
- Transfer of best practices

2009 Pro Forma Combined Income Statement

\$ in millions	TTM	Meadville	Pro Forma Combined ¹
Net sales	\$ 582.5	\$ 624.5	\$ 1,207.0
Gross profit	103.2	121.2	249.6
<i>Gross margin</i>	<i>17.7%</i>	<i>19.4%</i>	<i>20.7%</i>
Operating expenses			
Selling and marketing	26.5	19.0	45.3
General and administrative	36.5	50.3	76.5
Amortization of definite-lived intangibles	3.4	0.2	13.4
Restructuring charges	5.5	-	5.5
Impairment of long-lived assets	12.8	2.8	15.6
Operating income	18.5	48.9	93.3
Net income	4.9	32.3	52.6
Net income attributable to stockholders	\$ 4.9	\$ 23.2	\$ 40.8

¹ Pro forma adjustments are disclosed in the Form 8-K/A filed with the SEC on April 26, 2010

Quarterly Results

(\$ in Millions, except EPS)

	2009				2010	
	1Q	2Q	3Q	4Q	1Q	2QE
Revenue	\$149.0	\$144.5	\$139.1	\$149.9	\$138.2	\$290 - \$310
Gross Profit	\$24.3	\$27.1	\$24.2	\$27.7	\$27.0	
Gross Margin	16.3%	18.7%	17.4%	18.5%	19.5%	17.5 - 19.5%
Operating Income (Loss)	\$5.0	\$12.2	(\$5.4)	\$6.6	\$9.9	
GAAP Diluted EPS	\$0.03	\$0.14	(\$0.11)	\$0.05	\$0.10	\$0.03 - \$0.12
Non-GAAP Diluted EPS	\$0.12	\$0.20	\$0.18	\$0.19	\$0.19	\$0.16 - \$0.25
Operating Cash Flow	\$16.3	\$27.3	\$13.7	\$16.7	\$6.3	
Free Cash Flow	\$12.7	\$25.5	\$10.5	\$14.5	\$6.7	

Combined Investment Highlights

"Global Presence, Local Knowledge"

- Leading Global PCB Products Manufacturer
- Established Market Positions Across Diverse and Attractive Market Segments
- Attractive Tier-1 Customer List
- Integrated Global Sales and Manufacturing Platform Provides True One-Stop Solution
- Industry-Leading Financial Performance
- Strong and Capable Management Team With Extensive Experience in the PCB Manufacturing Industry